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substrates;

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the sealant, end spacers, and tacker between the two;

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curing the tacker after the aligning;

by curing the sealant after the tacking; and

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2. A method for manufacturing a flat display element according to claim 1, wherein the locating the end spacers and the tacker includes spreading the tacker loaded with the end spacers over the
5 motherboard.

3. A method for manufacturing a flat display element according to claim 1, wherein the locating the end spacers and the tacker includes forming pillar-shaped end spacers on the motherboard and then
10 spreading the tacker over the motherboard so as to cover the end spacers.

4. A method for manufacturing a flat display element according to claim 1, wherein the end spacers and the tacker are located at least in four corners at
15 the end portions of the motherboard.

5. A method for manufacturing a flat display element comprising a pair of substrates opposed to each other across a given gap and including respective peripheral edge portions thereof stuck on each other
20 with a sealant, a plurality of spacer posts arranged between the substrates and maintaining the gap between the substrates, and an optical modulation layer sealed in a region surrounded by the sealant, the method comprising:

25 preparing a pair of motherboards greater than the substrates;

forming a display forming portion on each

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motherboard;

locating the sealant on at least one of the
motherboards so as to surround peripheral edge portion
of the display forming portion and locating, on end
portions of the motherboard, end spacers for
maintaining the gap between the two motherboards and a
tacker covering the end spacers;

sticking the two motherboards on each other with
the sealant, end spacers, and tacker between the two;

aligning the two stuck motherboards with each
other;

tacking the two motherboards to each other by
curing the tacker after the aligning;

finally bonding the two motherboards to each other
by curing the sealant after the tacking; and

cutting the two motherboards outside the sealant
after the final bonding so as to obtain the substrates.

6. A method for manufacturing a flat display
element according to claim 5, wherein the locating the
end spacers and the tacker includes spreading the
tacker loaded with the end spacers over the
motherboard.

7. A method for manufacturing a flat display
element according to claim 5, wherein the locating the
end spacers and the tacker includes forming pillar-
shaped end spacers on the motherboard and then
spreading the tacker over the motherboard so as to

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12. A method for manufacturing a flat display element according to claim 5, wherein the end spacers and the tacker are located at least in the four corners at the end portions of the motherboard.